HAMAMATSU

PHOTON IS OUR BUSINESS



Micro-spectrometer

C12666MA

Finger-tip size, ultra-compact spectrometer head integrating MEMS and image sensor technologies

The C12666MA is an ultra-compact (Finger-tip size) spectrometer head developed based on our MEMS and image sensor technologies. The adoption of a newly designed optical system has achieved a remarkably small size, less than half the volume of the previous mini-spectrometer MS series (C10988MA-01). In addition, the employment of hermetic packaging has improved humidity resistance.

This product is suitable for integration into a variety of devices, such as integration into printers and hand-held color monitoring devices that require color management. It is also suitable for applications that collaborate with portable devices, such as smartphones and tablets.

Features

- Finger-tip size: $20.1 \times 12.5 \times 10.1$ mm
- Weight: 5 g
- Spectral response range: 340 to 780 nm
- **■** Spectral resolution: 15 nm max.
- Hermetic package: High reliability against humidity
- Installation into mobile measurement equipment
- **→** Wavelength conversion factor*1 is listed on final inspection sheet

- Applications

- Color monitoring for printers and printing machines
- Testers for lights and LEDs
- **→** Color adjustment of various large size displays
- Water quality control monitors and other environment measuring instruments
- Measuring instruments that use portable devices such as smartphones and tablets

Optical characteristics

Parameter	Value	Unit
Spectral response range	340 to 780	nm
Spectral resolution (FWHM)	15 max.	nm
Wavelength reproducibility*2	-0.5 to +0.5	nm
Wavelength temperature dependence	-0.1 to +0.1	nm/°C
Spectral stray light*3	-25	dB

^{*2:} Measured under constant light input conditions

Electrical characteristics

Parameter	Min.	Тур.	Max.	Unit
Supply voltage	4.75	5	5.25	V
Power consumption	-	30	-	mW
Video rate	0.25	-	200	kHz
Output impedance	-	150 *4	-	Ω

^{*4:} An increase in the current consumption at the video output terminal also increases the chip temperature and so causes the dark current to rise. To avoid this, connect a buffer amplifier for impedance conversion to the video output terminal so that the current flow is minimized. As the buffer amplifier, use a JFET or CMOS input operational amplifier of optical input impedance.

^{*1:} A conversion factor for converting the image sensor pixel number into a wavelength. A calculation factor for converting the A/D converted count into the input light level is not provided.

^{*3:} Spectral stray light = $10 \times \log (TI/Th)$

Th: count measured when light at a certain wavelength is input

TI: count measured at a wavelength 40 nm longer or shorter than the input light wavelength

Structure

Parameter	Specification	Unit
Dimensions (W \times D \times H)	20.1 × 12.5 × 10.1	mm
Weight	5	g
Slit*5 (H × V)	50 × 750	μm
NA*6	0.22	-
Image sensor (H × V)	CMOS linear image sensor with a slit	-
Number of pixels	256	pixels
Pixel size (H × V)	12.5 × 1000	μm

^{*5:} Entrance slit aperture size

Absolute maximum ratings

Parameter	Value	Unit
Operating temperature*7	+5 to +50	°C
Storage temperature*7	-20 to +70	°C

*7: No dew condensation

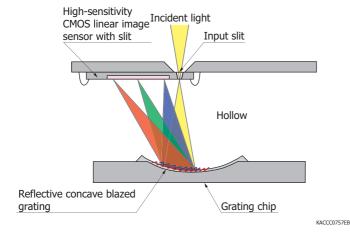
When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Optical component layout

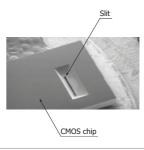
Besides a CMOS image sensor chip integrated with an optical slit by etching technology, the C12666MA employs a reflective concave blazed grating formed by nanoimprint. In addition, the glass used in the light path of the previous C10988MA-01 is not used in the C12666MA, making it extremely compact.

Structure



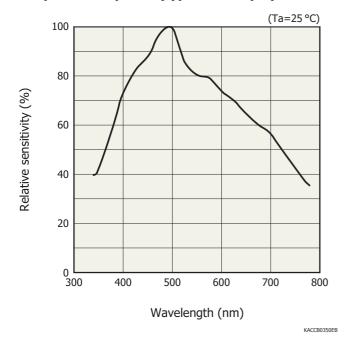


CMOS linear image sensor with a slit [Incident light side (back of chip)]

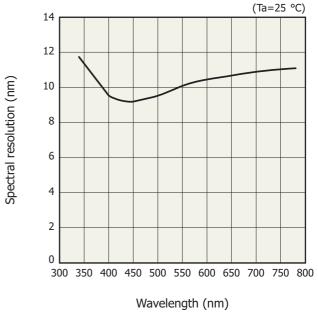


^{*6:} Numeric aperture (solid angle)

Spectral response (typical example)

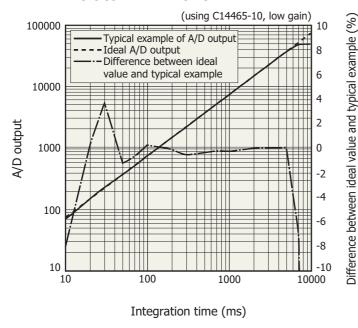


- Spectral resolution vs. wavelength (typical example)



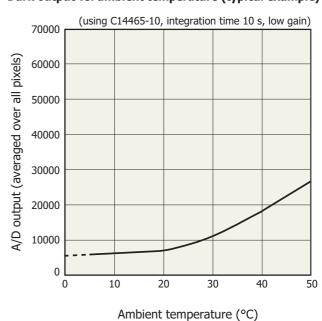
KACCB0351EA

Linearity (typical example)



A/D output is the output with dark output is subtracted when light is input. The difference between the ideal value and typical example contains a measurement error. The smaller the A/D output, the larger the measurement error.

→ Dark output vs. ambient temperature (typical example)



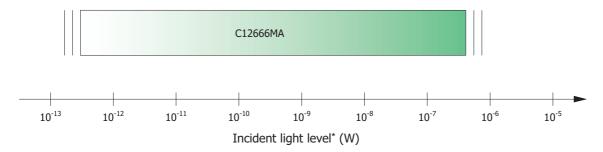
A/D output is the sum of the sensor and circuit offset outputs and the sensor dark output.

KACCB0354EC

KACCB0352EB



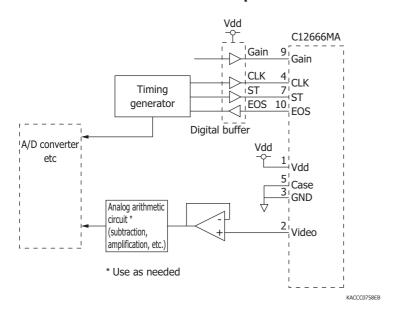
Measurable incident light level



^{*} Input spot diameter: 800 μ m (λ =550 nm)

KACCB354EA

- Recommended driver circuit example

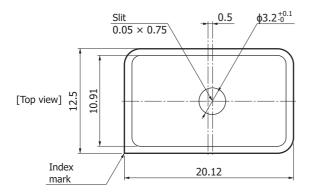


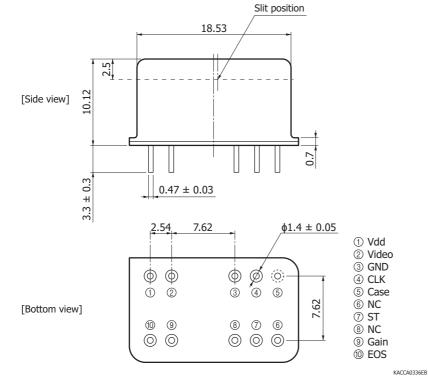
Precautions

- The packaging of C12666MA is electrically conductive, so be careful when designing the circuit to avoid short circuit caused by contact with a circuit pattern.
- \cdot If external force is repeatedly applied to the lead pins, this may damage the lead pins.
- To prevent damage due to soldering, be careful of the soldering temperature and time.

 As a general guide, finish soldering within 3.5 seconds at 350 °C or less when soldering by hand, or within 10 seconds at 260 °C or less when using a solder bath.

Dimensional outline (unit: mm, tolerance unless otherwise noted: ±0.2)





Pin connections

Make electrical connections to an external circuit using leads.

Pin no.	Symbol	Name	I/O	Description
1	Vdd	Supply voltage	I	Image sensor power supply: 5 V
2	Video	Video output	0	Video output signal
3	GND	Ground	-	Sensor ground
4	CLK	Clock pulse	I	Sensor scan sync signal
5	Case	Case	-	Case connection terminal
6	NC		-	No connection
7	ST	Start pulse	I	Start pulse
8	NC		-	No connection
9	Gain	Gain	I	Image sensor: Gain setting
10	EOS	End of scan	0	Sensor scan end signal

Note: Pin no. 9 is pulled up internally to Vdd via 10 k Ω .

Do not pull-up or pull-down the gain setting using an external circuit. For low gain, leave the pin open or connect to Vdd. For high gain, connect to GND.



Internal CMOS image sensor specifications

⇒ Recommended terminal voltage

Parameter		Symbol	Min.	Тур.	Max.	Unit
Supply voltage		Vdd	4.75	5	5.25	V
Gain selection terminal	High gain	Gain	0	-	0.4	V
voltage	Low gain	Gaili	Vdd - 0.25	Vdd	Vdd + 0.25	V
Clask mulas valtara	High level	V(CLK)	Vdd - 0.25	Vdd	Vdd + 0.25	V
Clock pulse voltage	Low level	V(CLK)	0	-	0.4	V
Start pulse voltage	High level	V(ST)	Vdd - 0.25	Vdd	Vdd + 0.25	V
	Low level	V(S1)	0	-	0.4	V

■ Electrical characteristics [Ta=25 °C, Vdd=5 V, V(CLK)=V(ST)=5 V]

Parameter		Symbol	Min.	Тур.	Max.	Unit
Clock pulse frequency		f(CLK)	1	-	800	kHz
Dower concumption	High gain	D	-	-	60	m\//
Power consumption	Low gain		-	-	60	mW

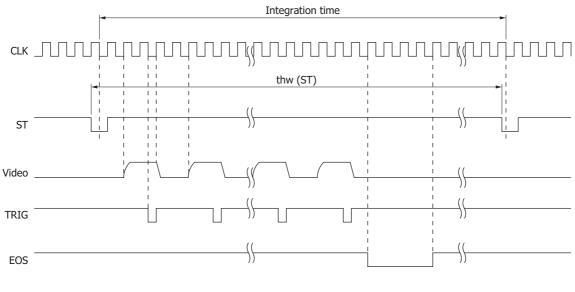
= Electrical and optical characteristics [Ta=25 °C, Vdd=5 V, V(CLK)=V(ST)=5 V]

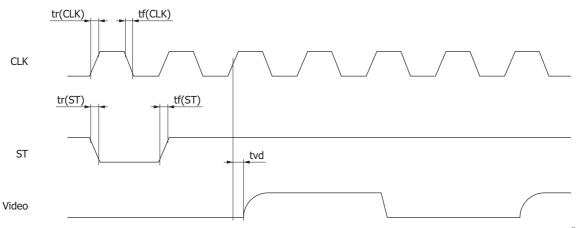
Parameter		Symbol	Min.	Тур.	Max.	Unit
Dark current	High gain	ID	-	0.02	0.08	pA
Dark Current	Low gain	טו	-	0.02	0.08	
Output offset voltage	High gain	Vo	0.15	0.35	0.55	V
Output offset voltage	Low gain	VO [0.15	0.35	0.55	V
Charge amplifier feedback	High gain	Cf	-	1.4	-	pF
capacitance*8	Low gain	Ci	-	4.8	-	Ы
Caturation output voltage*9	High gain	Vsat	2.3	2.8	3.3	V
Saturation output voltage*9	Low gain	VSat	1.4	1.7	2.0	V
Readout noise	High gain	Nr	-	0.3	0.5	mV rms
Reducit Hoise	Low gain	INI	-	0.2	0.4	IIIV IIIIS

^{*8:} Gain=5 V (low gain), Vg=0 V (high gain) *9: Voltage difference relative to Vo



- Timing chart





Parameter	Symbol	Min.	Тур.	Max.	Unit
Start pulse high period	thw(ST)	1030/f(CLK)	-	-	S
Start pulse rise/fall times	tr(ST), tf(ST)	0	20	30	ns
Clock pulse duty ratio	-	45	50	55	%
Clock pulse rise/fall times	tr(CLK), tf(CLK)	0	20	30	ns
Video delay time	tvd	-	20	-	ns

Note: The clock pulse should be set from high to low just once when the start pulse is low. The internal shift register starts operating at this timing.

The integration time is determined by the start pulse intervals. However, since the charge integration of each pixel is carried out between the signal readout of that pixel and the next signal readout of the same pixel, the start time of charge integration differs depending on each pixel. In addition, the next start pulse cannot be input until signal readout from all pixels is completed. Video output is 1/4 of the clock pulse frequency.



Micro-spectrometer evaluation circuit C14465-10 (sold separately)

The C14465-10 is a circuit board designed to simply evaluate the characteristics of the micro-spectrometer. The characteristics of the micro-spectrometer can be evaluated using the evaluation software by connecting the micro-spectrometer to a PC with a USB cable A9160 (AB type, sold separately)*¹⁰.

Features

- Initial evaluation circuit for micro-spectrometer*11
- Wavelength conversion factors of the micro-spectrometer can be input from a PC.*12
- → High A/D resolution (16-bit)
- USB powered
- *10: Compatible OS:

Microsoft® Windows® 7 Professional SP1 (32-bit, 64-bit)

Microsoft Windows 8 Professional (32-bit, 64-bit)

Microsoft Windows 10 Professional (32-bit, 64-bit)

- *11: The C14465-10 is a modified version of the C14465 evaluation circuit for the previous mini-spectrometer MS series (C10988MA-01, C11708MA). Only the sensor board has been modified. If you already have the C14465, you only have to purchase the C14465-03 (the sensor board for micro-spectrometers) to evaluate C12666MA micro-spectrometers.
- *12: A typical wavelength conversion factor is entered at the time of shipment of the C14465-10. To measure a spectrum with higher wavelength accuracy, it is necessary to input the wavelength conversion factor listed in the final inspection sheet that comes with each micro-spectrometer.

Note: Microsoft and Windows are registered trademarks of Microsoft Corporation in the United States and/or other countries.



Parameter	Specification	Unit
Interface	USB 2.0	-
A/D conversion	16	bit
Clock pulse frequency	800	kHz
Video rate	200	kHz
Integration time	5 to 10000	ms

Structure

Parameter		Specification	Unit
Applicable spect	trometer	C12666MA	-
Dimonsions	Control board	80 × 60	mm
Dimensions	Sensor board	30 × 44	mm

Absolute maximum ratings

Parameter	Value	Unit
Operating temperature*13	+5 to +40	°C
Storage temperature*13	-20 to +70	°C

^{*13:} No dew condensation

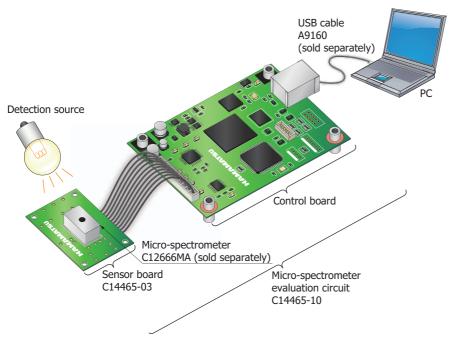
When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.



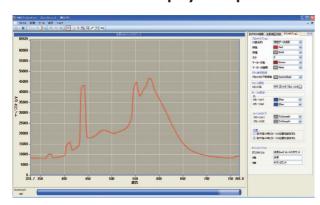


Connection example



KACCC0759EC

Evaluation software display example



► Mini-spectrometer/micro-spectrometer lineup

Type no.		Туре								al res											Spectral resolution max.	Image sensor
туре по.		, ,	200	400) (500	800	10	00	1200	14	100	1600	0 18	800	2000	2200	240) 20	600	(nm)	image sensor
C10082CA		TM-UV/VIS-CCD High sensitivity																			6	Back-thinned CCD
C10082CAH		TM-UV/VIS-CCD High resolution		200	to	800															1*	image sensor
C10082MD	meter	TM-UV/VIS-MOS Wide dynamic range																			6	CMOS linear image sensor
C10083CA	Mini-spectrometer TM series	TM-VIS/NIR-CCD High sensitivity																			8 (λ=320 to 900 nm)	Back-thinned CCD
C10083CAH	Mini-s TM se	TM-VIS/NIR-CCD High resolution			330) to	1000	\bot													1* (λ=320 to 900 nm)	image sensor
C10083MD		TM-VIS/NIR-MOS Wide dynamic range		T	320		1000	П													8	CMOS linear image sensor
C11697MB		TM-VIS/NIR-MOS-II Trigger-compatible																			8	High-sensitivity CMOS linear image sensor
C9404CA		TG-UV-CCD High sensitivity	200	to 400																	3	Back-thinned CCD
C9404CAH	meter	TG-UV-CCD High resolution	200	10 400																	1*	image sensor
C9405CB	Mini-spectrometer TG series	TG-SWNIR-CCD-II IR-enhanced				500) to 1	100													5 (λ=550 to 900 nm)	IR-enhanced back-thinned CCD image sensor
C11713CA	Mini-s TG se	TG-RAMAN-I High resolution				5	00 to	600)												0.3*	Back-thinned CCD image sensor
C11714CB		TG-RAMAN-II High resolution						7	90	to 92	20										0.3*	IR-enhanced back-thinned CCD image sensor
C11482GA	er	TG2-NIR Non-cooled type								900 t	a 1	700									7	
C9913GC	Mini-spectrometer TG series	TG-cooled NIR-I Low noise (cooled type)								00 1	0 1.	/00									7	InGaAs linear
C9914GB	ii-spec series	TG-cooled NIR-II Low noise (cooled type)									1		100 to		200						8	image sensor
C11118GA	ÄΕ	TG-cooled NIR-III Low noise (cooled type)											900	to	255	0					20	
C13053MA	meter	TF-SWIR-MOS-II Compact, thin case				500) to 1	100													3.5	I II also associate de c
C13054MA	Mini-spectrometer TF series	TF-RAMAN Compact, thin case						7	90	to 92	20										0.4*	High-sensitivity CMOS linear image sensor
C13555MA	Mini-s TF ser	TF-VIS-MOS-II Compact, thin case		3	40 t	to 8	30														3	illage selisul
C11007MA	trometer	RC-VIS-MOS Spectrometer module		34	0 to	78	0														9	CMOS linear image sensor
C11008MA	Mini-spectrometer I RC series	RC-SWNIR-MOS Spectrometer module				6	40 to	1050	0												8	IR-enhanced CMOS linear image sensor

^{*} Typ.

For installation into	mobile meası	ırina eauipment
-----------------------	--------------	-----------------

1 of miscandion med	To installation into mostle measuring equipment																
Type no.		Туре	200	Spectral response range (min)										Spectral resolution max. (nm)	Image sensor		
C11009MA	trometer	RC-VIS-MOS Spectrometer head		340	to 78	80										9	CMOS linear image sensor
C11010MA	Mini-sped RC series				6	40 to	1050									8	IR-enhanced CMOS linear image sensor

For installation into mobile meas	ring equipment (ultra-compact)
-----------------------------------	--------------------------------

Type no.		Туре	200	Spectral response range (IIII)												Spectral resolution max. (nm)	Image sensor
C11708MA	Mini-spectrometer MS series	MS-SWNIR-MOS Spectrometer head			ϵ	40 to	1050									20	CMOS linear image sensor
C12666MA	meter	Spectrometer head		340	to 78	80										15	CMOS linear image sensor
C12880MA	Micro- spectro	Spectrometer head		34	0 to 8	50										15	High-sensitivity CMOS linear image sensor



Micro-spectrometer

C12666MA

Related information

www.hamamatsu.com/sp/ssd/doc en.html

- Precautions
- · Disclaimer
- Technical information
- · Mini-spectrometers

Information described in this material is current as of November 2017.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.

AMAMATSU

www.hamamatsu.com

HAMAMATSU PHOTONICS K.K., Solid State Division

HAMAMATSO PHOTONICS K.K., Solid State Division

1126-1 Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81) 53-434-3311, Fax: (81) 53-434-5184

U.S.A.: Hamamatsu Corporation: 360 Foothill Road, Bridgewater, NJ., 08807, U.S.A., Telephone: (1) 908-231-0960, Fax: (1) 908-231-1218, E-mail: usa@hamamatsu.com

Germany: Hamamatsu Photonics Deutschland GmbH: Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany, Telephone: (49) 8152-375-0, Fax: (49) 8152-265-8, E-mail: info@hamamatsu.de

France: Hamamatsu Photonicis France S.A.R.L.: 19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massy Cedex, France, Telephone: 433-31(1) 69 53 71 10, Fax: 33-(1) 69 53 71 10, Fax: 401 707-294888, Fax: (49) 1707-294888, Fax: (49) 1807-294888, Fax: (49) 1807-29